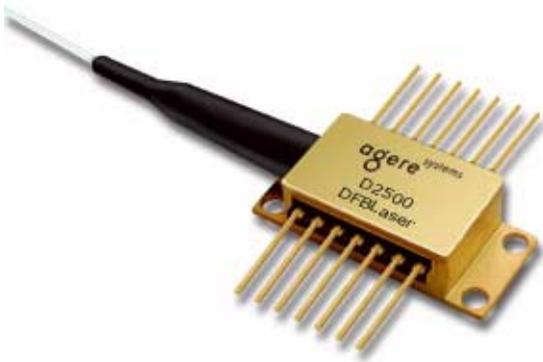


## 1.5 $\mu\text{m}$ D2500-Type Digital Isolated DFB Laser Module



The 1.5  $\mu\text{m}$  D2500-Type Laser Module is offered in a 14-pin, hermetic, butterfly package.

### Features

- Integrated optical isolator
- SONET/SDH compatible up to OC-48/STM-16
- High-performance, multiquantum-well (MQW), distributed-feedback (DFB) laser
- Low dispersion penalty for long-reach and extended-reach applications
- Industry-standard, 14-pin butterfly package
- Characterized at 2.488 Gbits/s (NRZ)
- Wide operating case temperature range of  $-40\text{ }^{\circ}\text{C}$  to  $+70\text{ }^{\circ}\text{C}$
- InGaAs, PIN photodetector back-facet monitor
- Low threshold current
- High reliability
- High optical power available
- Qualified to meet the intent of *Telcordia Technologies*<sup>™</sup> 468

### Applications

- Telecommunications:
  - SONET/SDH
  - Long reach
  - Interexchange
- Digital video

## Description

The D2500-type digital isolated DFB laser module contains an internally cooled, InGaAsP, MQW, distributed-feedback (DFB) laser designed for 1.5  $\mu\text{m}$  applications. The laser is designed to be used in OC-12/STM-4 (622 Mbits/s) and OC-48/STM-16 (2.488 Gbits/s) for long-reach and extended-reach applications. It is also capable of low dispersion penalties (<2 dB) for use with fiber spans exceeding 170 km (3000 ps/nm).

The device is available with an average output power of 0 dBm (3 dBm peak), which meets the SONET/SDH standard. To eliminate the need for optical amplifiers in some applications, the module can also be ordered with higher output powers.

## Controlled Feedback

The module contains an internal optical isolator that suppresses optical feedback in laser-based, fiber-optic systems. Light reflected back to the laser is attenuated a minimum of 30 dB.

## Controlled Temperature

An integral thermoelectric cooler (TEC) provides stable thermal characteristics. The TEC allows for heating and cooling of the laser chip to maintain a temperature of 25  $^{\circ}\text{C}$  for case temperatures from  $-40^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$ . The laser temperature is monitored by the internal thermistor, which can be used with external circuitry to control the laser chip temperature.

## Controlled Power

An internal, InGaAs, PIN photodiode functions as the back-facet monitor. The photodiode monitors emission from the rear facet of the laser and, when used in conjunction with control circuitry, can control optical power launched into the fiber. Normally, this configuration is used in a feedback arrangement to maintain the average laser output power.

## Standard Package

The laser module is fabricated in a 14-pin, hermetic, metal/ceramic butterfly package. The package also incorporates a bias tee that separates the dc-bias path from the RF input. The RF input has a nominal 25  $\Omega$  impedance. The laser module is equipped with a single-mode fiber with an 8  $\mu\text{m}$  core and 125  $\mu\text{m}$  cladding.

The minimum pigtail length is 39.4 in. (100 cm); the minimum bend radius is 1.23 in. (31.25 mm).

The pigtail is a 900  $\mu\text{m}$  tight buffer fiber. Various connector and pigtail options are available.

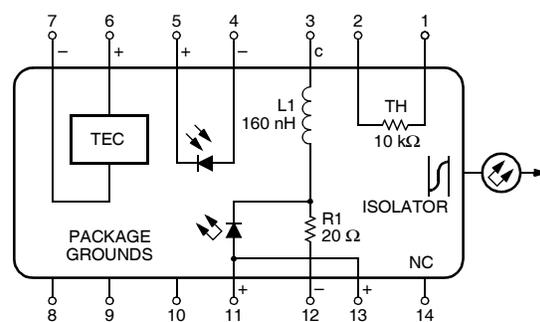
Optoelectronic components produced by Agere Systems Inc. are qualified to rigorous internal standards that are consistent with *Telcordia Technologies* TR-NWT-000468. All design and manufacturing operations are ISO<sup>®</sup> 9001 certified. The module is fully qualified for central office applications.

## Pin Information

Pin	Name
1	Thermistor
2	Thermistor
3	Laser dc Bias (cathode) (-)
4	Back-facet Monitor Anode (-)
5	Back-facet Monitor Cathode (+)
6	Thermoelectric Cooler (+)*
7	Thermoelectric Cooler (-)*
8	Case Ground
9	Case Ground
10	Case Ground
11	Laser Anode (+) †
12	RF Laser Input Cathode (-)
13	Laser Anode (+) †
14	Case Ground

\* A positive current through the thermoelectric heat pump cools the laser.

† Both leads should be grounded for optimum performance.



Top view.

Figure 1. Circuit Schematic

1-567

## Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the performance characteristics of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Symbol	Min	Max	Unit
Laser Reverse Voltage	VRLMAX	—	2	V
dc Forward Current	IFLMAX	—	150	mA
Operating Case Temperature Range	T <sub>C</sub>	-40	70	°C
Storage Case Temperature Range*	T <sub>stg</sub>	-40	85	°C
Photodiode Reverse Voltage	VRPDMAX	—	10	V
Photodiode Forward Current	IFPDMAX	—	1	mA

\* Does not apply to shipping container.

## Handling Precautions

### Power Sequencing

To avoid the possibility of damage to the laser module from power supply switching transients, follow this turn-on sequence:

1. All ground connections
2. Most negative supply
3. Most positive supply
4. All remaining connections

Reverse the order for the proper turn-off sequence.

### Electrostatic Discharge

**CAUTION: This device is susceptible to damage as a result of electrostatic discharge. Take proper precautions during both handling and testing. Follow guidelines such as JEDEC Publication No. 108-A (Dec. 1988).**

Agere Systems employs a human-body model (HBM) for ESD-susceptibility testing and protection-design evaluation. ESD voltage thresholds are dependent on the critical parameters used to define the model. A standard HBM (resistance = 1.5 kΩ, capacitance = 100 pF) is widely used and can be used for comparison purposes. The HBM ESD threshold presented here was obtained using these circuit parameters:

Parameter	Value	Unit
Human-body Model	>400	V

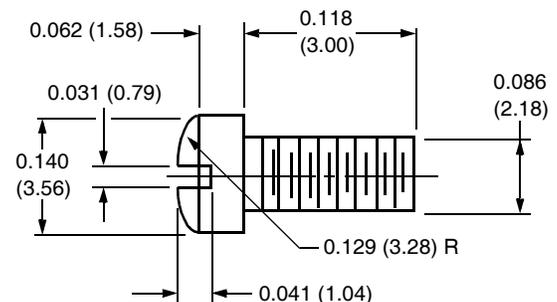
Agere Systems Inc.

## Mounting Instructions

The minimum fiber bend radius is 31.25 mm (1.23 in.).

To avoid degradation in performance, mount the module on the board as follows:

1. Place the bottom flange of the module on a flat heat sink at least 0.5 in. x 1.180 in. (12.7 mm x 30 mm) in size. The surface finish of the heat sink should be better than 32 μin. (0.8 μm), and the surface flatness must be better than 0.001 in. (25.4 μm). Using thermal conductive grease is optional; however, thermal performance can be improved by up to 5% if conductive grease is applied between the bottom flange and the heat sink.
2. Mount four #2-56 screws with Fillister heads (M2-3 mm) at the four screw-hole locations (see Outline Diagram). The Fillister head diameter must not exceed 0.140 in. (3.55 mm). Do not apply more than 1 in.-lb. of torque to the screws.



Note: Dimensions are in inches and (millimeters).

Figure 2. Fillister Head Screw

1-532

## Characteristics

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information purposes only and are not part of the testing requirements.

**Table 1. Electrical Characteristics (at 25 °C Laser Temperature)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Laser Forward Voltage	VLF	LF = 2 mW (CW)	—	1.3	1.8	V
Laser Submount Temperature	T <sub>LASER</sub>	—	—	25	—	°C
Slope Efficiency	$\eta$	LF = 2 mW (CW)	0.025	0.10	—	mW/mA
Threshold Current	I <sub>TH</sub>	—	—	12	50	mA
Monitor Reverse-bias Voltage*	V <sub>RMON</sub>	—	3	5	10	V
Monitor Current	I <sub>RMON</sub>	P <sub>O</sub> = 1 mW (CW)	0.1	1.0	2.0	mA
Monitor Dark Current	I <sub>D</sub>	I <sub>F</sub> = 0, V <sub>RMON</sub> = 5 V	—	0.01	0.1	$\mu\text{A}$
Input Impedance	Z <sub>IN</sub>	—	—	25	—	$\Omega$
Thermistor Current	I <sub>TC</sub>	—	10	—	100	$\mu\text{A}$
Resistance Ratio <sup>†</sup>	—	—	9.1	9.6	10.1	—
Thermistor Resistance	R <sub>TH</sub>	T <sub>L</sub> = 25 °C	9.5	—	10.5	k $\Omega$
TEC Current	I <sub>TEC</sub>	T <sub>L</sub> = 25 °C, T <sub>c</sub> = 70 °C	—	0.6	1.0	A
TEC Voltage	V <sub>TEC</sub>	T <sub>L</sub> = 25 °C, T <sub>c</sub> = 70 °C	—	1.3	2.0	V
TEC Capacity	$\Delta T$	T <sub>c</sub> = 70 °C	—	—	50	°C

\* Standard operating condition is 5.0 V reverse bias.

<sup>†</sup> Ratio of thermistor resistance at 0 °C to thermistor resistance at 50 °C.

**Table 2. Optical Characteristics (at 25 °C Laser Temperature)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Peak Optical Output Power	P <sub>PEAK</sub>	—	2.0	—	—	mW
Center Wavelength	$\lambda_C$	—	1530	—	1570	nm
Line Width (–3 dB full width)	$\Delta\lambda$	Modulated at 2.5 Gbits/s at rated power	—	2	10	MHz
Side-mode Suppression Ratio	SMSR	Modulated at 2.5 Gbits/s	30	—	—	dB
Optical Isolation	—	0 °C to 65 °C	30	—	—	dB
Wavelength Drift (EOL)	$\Delta\lambda$	Tested over 25-year lifetime	—	—	$\pm 0.1$	nm
Center Wavelength Drift with Case Temperature	$\Delta\lambda_c/\Delta T_c$	0 °C $\leq$ T <sub>c</sub> $\leq$ 70 °C	—	—	1	$\mu\text{m}/^\circ\text{C}$

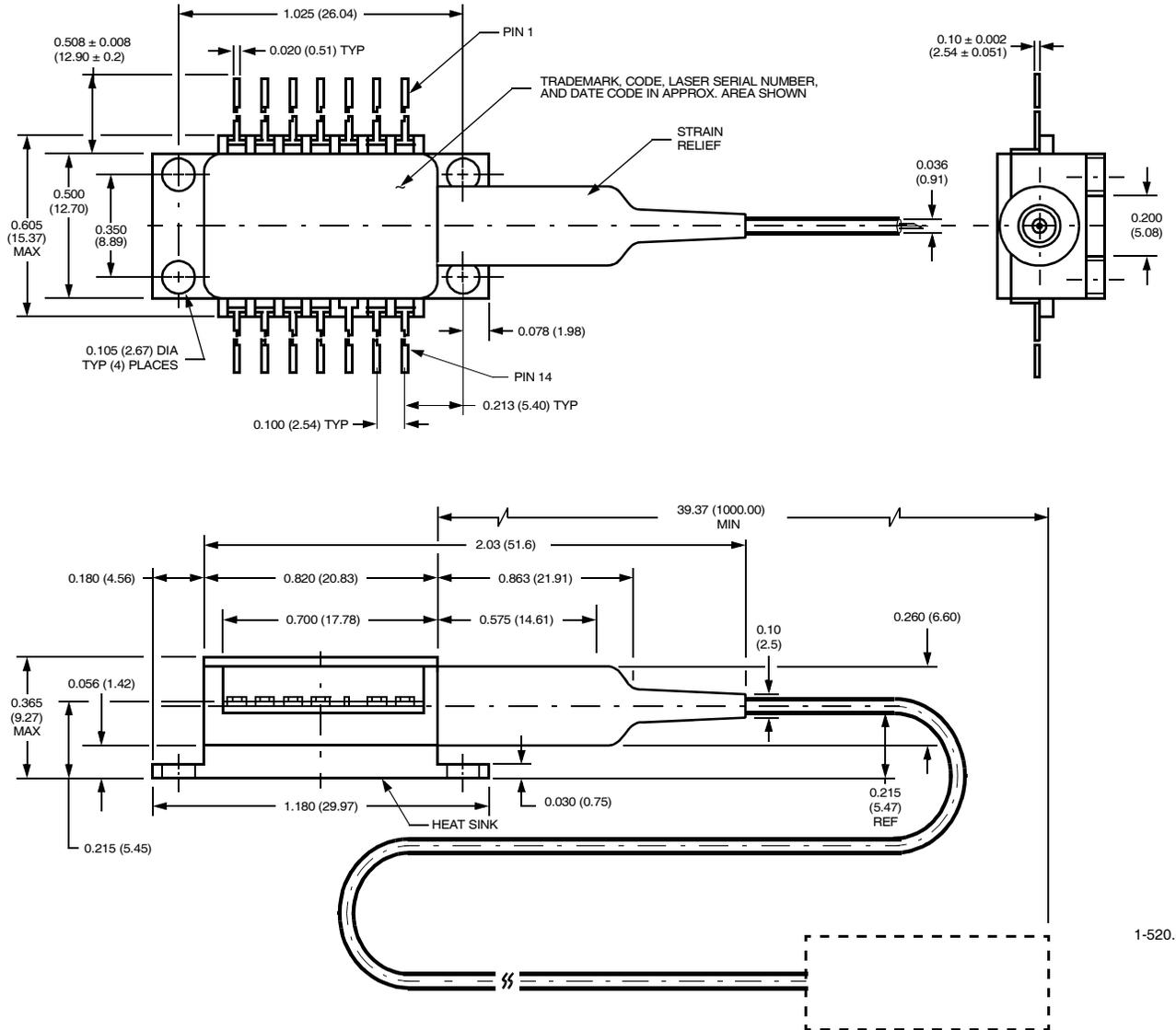
**Table 3. Dispersion Performance** (examples of dispersion penalty specifications)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Dispersion Penalty:*						
D2502	DP	1350 ps/nm	—	—	2.0	dB
D2511	DP	1800 ps/nm	—	—	2.0	dB
D2517	DP	3000 ps/nm	—	—	2.0	dB

\* Other dispersion penalties at various dispersions available.

### Outline Diagram

Dimensions are in inches and (millimeters). Tolerances are  $\pm 0.005$  in. ( $\pm 0.127$  mm).



## Laser Safety Information

### Class IIIb Laser Product

FDA/CDRH Class IIIb laser product. All versions are Class IIIb laser products per CDRH, 21 CFR 1040 Laser Safety requirements. The device has been classified with the FDA under accession number 8720010.

This product complies with 21 CFR 1040.10 and 1040.11.

8  $\mu\text{m}$ /125  $\mu\text{m}$  single-mode fiber pigtail with 900  $\mu\text{m}$  tight buffer jacket and connector

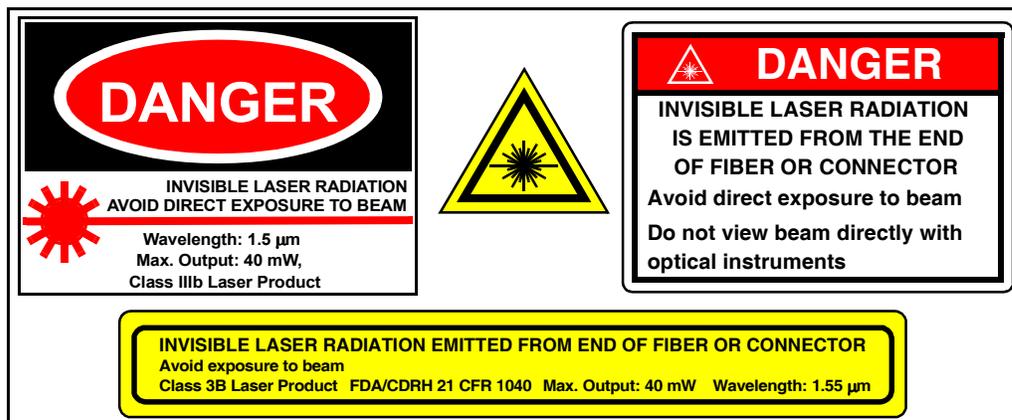
Wavelength = 1550 nm

Maximum power = 40 mW

Because of size constraints, laser safety labeling (including an FDA class IIIb label) is not affixed to the module but is contained in the shipping carton.

Product is not shipped with power supply.

**Caution: Use of controls, adjustments, and procedures other than those specified herein may result in hazardous laser radiation exposure.**



## Ordering Information

Table 4. Ordering Information

Device Code	Description	Connector*	Comcode
D2502G	1.5 $\mu$ m Digital DFB Laser	FC-PC	107952723
D2511G		FC-PC	107952814
D2511D		SC	108036898
D2517G		FC-PC	108198318
D2517D		SC	108054719

\* Other connectors available upon request.

*Telcordia Technologies* is a trademark of Telcordia Technologies, Inc.  
*ISO* is a registered trademark of The International Organization for Standardization.

For additional information, contact your Agere Systems Account Manager or the following:

INTERNET: <http://www.agere.com>

E-MAIL: [docmaster@agere.com](mailto:docmaster@agere.com)

N. AMERICA: Agere Systems Inc., 555 Union Boulevard, Room 30L-15P-BA, Allentown, PA 18109-3286

1-800-372-2447, FAX 610-712-4106 (In CANADA: 1-800-553-2448, FAX 610-712-4106)

ASIA: Agere Systems Hong Kong Ltd., Suites 3201 & 3210-12, 32/F, Tower 2, The Gateway, Harbour City, Kowloon

Tel. (852) 3129-2000, FAX (852) 3129-2020

CHINA: (86) 21-5047-1212 (Shanghai), (86) 10-6522-5566 (Beijing), (86) 755-695-7224 (Shenzhen)

JAPAN: (81) 3-5421-1600 (Tokyo), KOREA: (82) 2-767-1850 (Seoul), SINGAPORE: (65) 778-8833, TAIWAN: (886) 2-2725-5858 (Taipei)

EUROPE: Tel. (44) 7000 624624, FAX (44) 1344 488 045

Agere Systems Inc. reserves the right to make changes to the product(s) or information contained herein without notice. No liability is assumed as a result of their use or application.